

Data sheet acquired from Harris Semiconductor SCHS204J

CD54HC4046A, CD74HC4046A, CD54HCT4046A, CD74HCT4046A

February 1998 - Revised December 2003

Features

- Operating Frequency Range
 - Up to 18MHz (Typ) at V_{CC} = 5V
 - Minimum Center Frequency of 12MHz at V_{CC} = 4.5V
- Choice of Three Phase Comparators
 - EXCLUSIVE-OR
 - Edge-Triggered JK Flip-Flop
 - Edge-Triggered RS Flip-Flop
- Excellent VCO Frequency Linearity
- VCO-Inhibit Control for ON/OFF Keying and for Low Standby Power Consumption
- Minimal Frequency Drift
- Operating Power Supply Voltage Range
- Fanout (Over Temperature Range)

- Wide Operating Temperature Range ... -55°C to 125°C
- Balanced Propagation Delay and Transition Times
- Significant Power Reduction Compared to LSTTL Logic ICs
- HC Types
 - 2V to 6V Operation
 - High Noise Immunity: NIL = 30%, NIH = 30% of V_{CC} at V_{CC} = 5V
- HCT Types
 - 4.5V to 5.5V Operation
 - Direct LSTTL Input Logic Compatibility, V_{IL} = 0.8V (Max), V_{IH} = 2V (Min)
 - CMOS Input Compatibility, $I_{I} \leq 1 \mu A$ at VOL, VOH

Applications

- FM Modulation and Demodulation
- Frequency Synthesis and Multiplication
- Frequency Discrimination
- Tone Decoding
- Data Synchronization and Conditioning
- Voltage-to-Frequency Conversion
- Motor-Speed Control

High-Speed CMOS Logic Phase-Locked Loop with VCO

Description

The 'HC4046A and 'HCT4046A are high-speed silicon-gate CMOS devices that are pin compatible with the CD4046B of the "4000B" series. They are specified in compliance with JEDEC standard number 7.

The 'HC4046A and 'HCT4046A are phase-locked-loop circuits that contain a linear voltage-controlled oscillator (VCO) and three different phase comparators (PC1, PC2 and PC3). A signal input and a comparator input are common to each comparator.

The signal input can be directly coupled to large voltage signals, or indirectly coupled (with a series capacitor) to small voltage signals. A self-bias input circuit keeps small voltage signals within the linear region of the input amplifiers. With a passive low-pass filter, the 4046A forms a second-order loop PLL. The excellent VCO linearity is achieved by the use of linear op-amp techniques.

Ordering Information

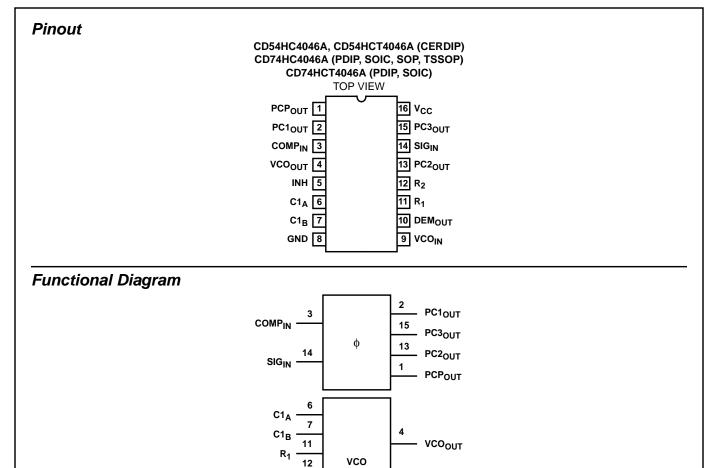
PART NUMBER	TEMP. RANGE (^o C)	PACKAGE
CD54HC4046AF3A	-55 to 125	16 Ld CERDIP
CD54HCT4046AF3A	-55 to 125	16 Ld CERDIP
CD74HC4046AE	-55 to 125	16 Ld PDIP
CD74HC4046AM	-55 to 125	16 Ld SOIC
CD74HC4046AMT	-55 to 125	16 Ld SOIC
CD74HC4046AM96	-55 to 125	16 Ld SOIC
CD74HC4046ANSR	-55 to 125	16 Ld SOP
CD74HC4046APWR	-55 to 125	16 Ld TSSOP
CD74HC4046APWT	-55 to 125	16 Ld TSSOP
CD74HCT4046AE	-55 to 125	16 Ld PDIP
CD74HCT4046AM	-55 to 125	16 Ld SOIC
CD74HCT4046AMT	-55 to 125	16 Ld SOIC
CD74HCT4046AM96	-55 to 125	16 Ld SOIC

NOTE: When ordering, use the entire part number. The suffixes 96 and R denote tape and reel. The suffix T denotes a small-quantity reel of 250.

CAUTION: These devices are sensitive to electrostatic discharge. Users should follow proper IC Handling Procedures.

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CD54HC4046A, CD74HC4046A, CD54HCT4046A, CD74HCT4046A



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DEMOUT

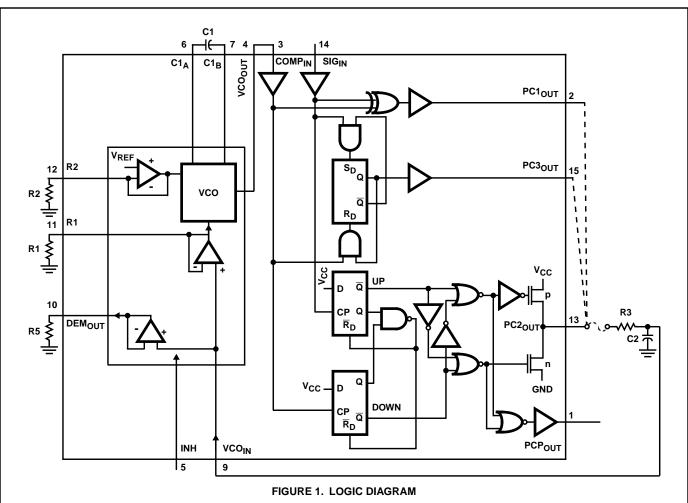
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VCOIN

INH

Pin Descriptions

PIN NUMBER	SYMBOL	NAME AND FUNCTION	
1	PCPOUT	Phase Comparator Pulse Output	
2	PC1 _{OUT}	Phase Comparator 1 Output	
3	COMPIN	Comparator Input	
4	VCO _{OUT}	VCO Output	
5	INH	Inhibit Input	
6	C1 _A	Capacitor C1 Connection A	
7	C1 _B	Capacitor C1 Connection B	
8	GND	Ground (0V)	
9	VCO _{IN}	VCO Input	
10	DEMOUT	Demodulator Output	
11	R ₁	Resistor R1 Connection	
12	R ₂	Resistor R2 Connection	
13	PC2 _{OUT}	Phase Comparator 2 Output	
14	SIG _{IN}	Signal Input	
15	PC3 _{OUT}	Phase Comparator 3 Output	
16	V _{CC}	Positive Supply Voltage	



General Description

vco

The VCO requires one external capacitor C1 (between $C1_A$ and $C1_B$) and one external resistor R1 (between R_1 and GND) or two external resistors R1 and R2 (between R_1 and GND, and R_2 and GND). Resistor R1 and capacitor C1 determine the frequency range of the VCO. Resistor R2 enables the VCO to have a frequency offset if required. See logic diagram, Figure 1.

The high input impedance of the VCO simplifies the design of low-pass filters by giving the designer a wide choice of resistor/capacitor ranges. In order not to load the low-pass filter, a demodulator output of the VCO input voltage is provided at pin 10 (DEMOUT). In contrast to conventional techniques where the DEMOUT voltage is one threshold voltage lower than the VCO input voltage, here the DEMOUT voltage equals that of the VCO input. If DEMOUT is used, a load resistor (R_S) should be connected from DEMOUT to GND; if unused, DEMOUT should be left open. The VCO output (VCO_{OUT}) can be connected directly to the comparator input (COMPIN), or connected via a frequencydivider. The VCO output signal has a specified duty factor of 50%. A LOW level at the inhibit input (INH) enables the VCO and demodulator, while a HIGH level turns both off to minimize standby power consumption.

Phase Comparators

The signal input (SIG_{IN}) can be directly coupled to the selfbiasing amplifier at pin 14, provided that the signal swing is between the standard HC family input logic levels. Capacitive coupling is required for signals with smaller swings.

Phase Comparator 1 (PC1)

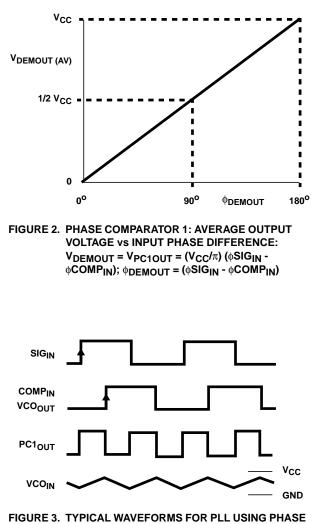
This is an Exclusive-OR network. The signal and comparator input frequencies (f_i) must have a 50% duty factor to obtain the maximum locking range. The transfer characteristic of PC1, assuming ripple ($f_r = 2f_i$) is suppressed, is:

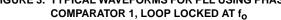
 $V_{DEMOUT} = (V_{CC}/\pi) (\phi SIG_{IN} - \phi COMP_{IN})$ where V_{DEMOUT} is the demodulator output at pin 10; $V_{DEMOUT} = V_{PC1OUT}$ (via low-pass filter).

The average output voltage from PC1, fed to the VCO input via the low-pass filter and seen at the demodulator output at pin 10 (V_{DEMOUT}), is the resultant of the phase differences of signals (SIG_{IN}) and the comparator input (COMP_{IN}) as shown in Figure 2. The average of V_{DEM} is equal to 1/2 V_{CC} when there is no signal or noise at SIG_{IN}, and with this input the VCO oscillates at the center frequency (f₀). Typical waveforms for the PC1 loop locked at f₀ are shown in Figure 3.

The frequency capture range $(2f_C)$ is defined as the frequency range of input signals on which the PLL will lock if it was initially out-of-lock. The frequency lock range $(2f_L)$ is defined as the frequency range of input signals on which the loop will stay locked if it was initially in lock. The capture range is smaller or equal to the lock range.

With PC1, the capture range depends on the low-pass filter characteristics and can be made as large as the lock range. This configuration retains lock behavior even with very noisy input signals. Typical of this type of phase comparator is that it can lock to input frequencies close to the harmonics of the VCO center frequency.



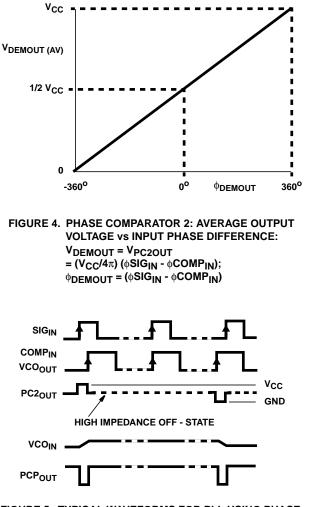


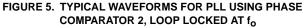
Phase Comparator 2 (PC2)

This is a positive edge-triggered phase and frequency detector. When the PLL is using this comparator, the loop is controlled by positive signal transitions and the duty factors of SIG_{IN} and COMP_{IN} are not important. PC2 comprises two D-type flip-flops, control-gating and a three-state output stage. The circuit functions as an up-down counter (Figure 1) where SIG_{IN} causes an up-count and COMP_{IN} a down-count. The transfer function of PC2, assuming ripple ($f_r = f_i$) is suppressed, is:

 $V_{DEMOUT} = (V_{CC}/4\pi) (\phi SIG_{IN} - \phi COMP_{IN})$ where V_{DEMOUT} is the demodulator output at pin 10; $V_{DEMOUT} = V_{PC2OUT}$ (via low-pass filter).

The average output voltage from PC2, fed to the VCO via the low-pass filter and seen at the demodulator output at pin 10 (V_{DEMOUT}), is the resultant of the phase differences of SIG_{IN} and COMP_{IN} as shown in Figure 4. Typical waveforms for the PC2 loop locked at f_0 are shown in Figure 5.





When the frequencies of SIG_{IN} and COMP_{IN} are equal but the phase of SIG_{IN} leads that of COMP_{IN}, the p-type output driver at PC2_{OUT} is held "ON" for a time corresponding to the phase difference (ϕ_{DEMOUT}). When the phase of SIG_{IN} lags that of COMP_{IN}, the n-type driver is held "ON".

When the frequency of SIG_{IN} is higher than that of COMP_{IN}, the p-type output driver is held "ON" for most of the input signal cycle time, and for the remainder of the cycle both n- and p-type drivers are "OFF" (three-state). If the SIG_{IN} frequency is lower than the COMP_{IN} frequency, then it is the n-type driver that is held "ON" for most of the cycle. Subsequently, the voltage at the capacitor (C2) of the low-pass filter connected to PC2_{OUT} varies until the signal and comparator inputs are equal in both phase and

frequency. At this stable point the voltage on C2 remains constant as the PC2 output is in three-state and the VCO input at pin 9 is a high impedance. Also in this condition, the signal at the phase comparator pulse output (PCP_{OUT}) is a HIGH level and so can be used for indicating a locked condition.

Thus, for PC2, no phase difference exists between SIG_{IN} and COMP_{IN} over the full frequency range of the VCO. Moreover, the power dissipation due to the low-pass filter is reduced because both p- and n-type drivers are "OFF" for most of the signal input cycle. It should be noted that the PLL lock range for this type of phase comparator is equal to the capture range and is independent of the low-pass filter. With no signal present at SIG_{IN}, the VCO adjusts, via PC2, to its lowest frequency.

Phase Comparator 3 (PC3)

This is a positive edge-triggered sequential phase detector using an RS-type flip-flop. When the PLL is using this comparator, the loop is controlled by positive signal transitions and the duty factors of SIG_{IN} and COMP_{IN} are not important. The transfer characteristic of PC3, assuming ripple ($f_r = f_i$) is suppressed, is:

 $V_{DEMOUT} = (V_{CC}/2p)$ (fSIG_{IN} - fCOMP_{IN}) where V_{DEMOUT} is the demodulator output at pin 10; V_{DEMOUT} = V_{PC3OUT} (via low-pass filter).

The average output from PC3, fed to the VCO via the lowpass filter and seen at the demodulator at pin 10 (V_{DEMOUT}), is the resultant of the phase differences of SIG_{IN} and COMP_{IN} as shown in Figure 6. Typical waveforms for the PC3 loop locked at f_o are shown in Figure 7.

The phase-to-output response characteristic of PC3 (Figure 6) differs from that of PC2 in that the phase angle between SIG_{IN} and $COMP_{IN}$ varies between 0° and 360° and is 180° at the center frequency. Also PC3 gives a greater voltage swing than PC2 for input phase differences but as aconsequence the ripple content of the VCO input signal is higher. With no signal present at SIG_{IN} , the VCO adjusts, via PC3, to its highest frequency.

The only difference between the HC and HCT versions is the input level specification of the INH input. This input disables the VCO section. The comparator's sections are identical, so that there is no difference in the SIG_{IN} (pin 14) or COMP_{IN} (pin 3) inputs between the HC and the HCT versions.

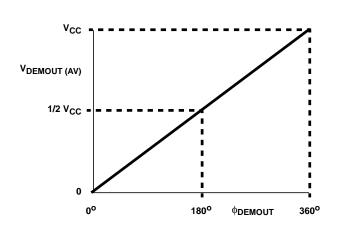
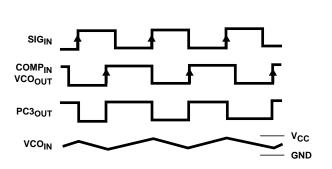
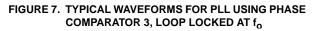


FIGURE 6. PHASE COMPARATOR 3: AVERAGE OUTPUT VOLTAGE vs INPUT PHASE DIFFERENCE: $V_{DEMOUT} = V_{PC3OUT}$ = ($V_{CC}/2\pi$) (ϕ SIG_{IN} - ϕ COMP_{IN});

 $\phi_{\text{DEMOUT}} = (\phi_{\text{SIGIN}} - \phi_{\text{COMPIN}}),$





Absolute Maximum Ratings

DC Supply Voltage, V _{CC} 0.5V to 7V DC Input Diode Current, I _{IK}
For $V_{l} < -0.5V$ or $V_{l} > V_{CC} + 0.5V$
DC Output Diode Current, I _{OK}
For $V_O < -0.5V$ or $V_O > V_{CC} + 0.5V$ ±20mA
DC Drain Current, per Output, IO
For -0.5V < V _O < V _{CC} + 0.5V±25mA
DC Output Source or Sink Current per Output Pin, IO
For $V_0 > -0.5V$ or $V_0 < V_{CC} + 0.5V$ ±25mA
DC V _{CC} or Ground Current, I _{CC} ±50mA

Operating Conditions

Temperature Range, T_A
Supply Voltage Range, V _{CC}
HC Types
HCT Types4.5V to 5.5V
DC Input or Output Voltage, V _I , V _O 0V to V _{CC}
Input Rise and Fall Time
2V
4.5V 500ns (Max)
6V

Thermal Information

Package Thermal Impedance, θ_{JA} (see Note 1):
E (PDIP) Package
M (SOIC) Package73 ^o C/W
NS (SOP) Package 64 ^o C/W
PW (TSSOP) Package 108 ^o C/W
Maximum Junction Temperature
Maximum Storage Temperature Range65°C to 150°C
Maximum Lead Temperature (Soldering 10s)
(SOIC - Lead Tips Only)

CAUTION: Stresses above those listed in "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress only rating and operation of the device at these or any other conditions above those indicated in the operational sections of this specification is not implied.

NOTE:

1. The package thermal impedance is calculated in accordance with JESD 51-7.

DC Electrical Specifications

		TE: CONDI	-	Vcc		25 ⁰ C		-40 ^о С т	O 85°C	-55°C TO 125°C			
PARAMETER	SYMBOL	V _I (V)	I _O (mA)	(V)	MIN	TYP	MAX	MIN	MAX	MIN	MAX	UNITS	
HC TYPES		-					-	_					
VCO SECTION													
INH High Level Input	VIH	-	-	3	2.1	-	-	2.1	-	2.1	-	V	
Voltage				4.5	3.15	-	-	3.15	-	3.15	-	V	
				6	4.2	-	-	4.2	-	4.2	-	V	
INH Low Level Input	VIL	-	-	3	-	-	0.9	-	0.9	-	0.9	V	
Voltage				4.5	-	-	1.35	-	1.35	-	1.35	V	
				6	-	-	1.8	-	1.8	-	1.8	V	
VCO _{OUT} High Level	V _{OH}	V _{IH} or V _{IL}	-0.02	3	2.9	-	-	2.9	-	2.9	-	V	
Output Voltage CMOS Loads			-0.02	4.5	4.4	-	-	4.4	-	4.4	-	V	
OMOO LOAds			-0.02	6	5.9	-	-	5.9	-	5.9	-	V	
VCO _{OUT} High Level	1		-	-	-	-	-	-	-	-	-	V	
Output Voltage TTL Loads			-4	4.5	 3.98 -	-	3.84	-	3.7	-	V		
			-5.2	6	5.48	-	-	5.34	-	5.2	MAX	V	
VCO _{OUT} Low Level	V _{OL}	$V_{\text{IH}} \text{ or } V_{\text{IL}}$	0.02	2	-	-	0.1	-	0.1	-	0.1	V	
Output Voltage CMOS Loads			0.02	4.5	-	-	0.1	-	0.1	5.9 - - - 3.7 - 5.2 - - 0.1 - 0.1 - 0.1	V		
emee Loads			0.02	6	-	-	0.1	-	0.1	-	1.8 - - - - 0.1 0.1 0.1 - -	V	
VCO _{OUT} Low Level	1		-	-	-	-	-	-	-	-	-	V	
Output Voltage TTL Loads			4	4.5	-	-	0.26	-	0.33	-	0.4	V	
			5.2	6	-	-	0.26	-	0.33	-	0.4	V	
C1A, C1B Low Level	V _{OL}	V _{IL} or V _{IH}	4	4.5	-	-	0.40	-	0.47	-	0.54	V	
Output Voltage (Test Purposes Only)			5.2	6	-	-	0.40	-	0.47	-	0.54	V	

DC Electrical Specifications (Continued)

		TE: CONDI	-	Vcc		25 ⁰ C		-40°C 1	O 85°C	-55°C T	O 125°C	
PARAMETER	SYMBOL	V _I (V)	I _O (mA)	(V)	MIN	TYP	MAX	MIN	MAX	MIN	MAX	UNITS
INH VCO _{IN} Input Leakage Current	lı	V _{CC} or GND	-	6	-	-	±0.1	-	±1	-	±1	μA
R1 Range (Note 2)	-	-	-	4.5	3	-	300	-	-	-	-	kΩ
R2 Range (Note 2)	-	-	-	4.5	3	-	300	-	-	-	-	kΩ
C1 Capacitance	-	-	-	3	-	-	No	-	-	-	-	pF
Range				4.5	-	-	Limit	-	-	-	-	pF
				6	-	-	1	-	-	-	-	pF
VCO _{IN} Operating	-	Over the		3	1.1	-	1.9	-	-	-	-	V
Voltage Range		specified f		4.5	1.1	-	3.2	-	-	-	-	V
		10, and (Note	34 - 37	6	1.1	-	4.6	-	-	-	-	V
PHASE COMPARATO	R SECTIO	N						-				
SIG _{IN} , COMP _{IN}	V _{IH}	-	-	2	1.5	-	-	1.5	-	1.5	-	V
DC Coupled High-Level Input			[4.5	3.15	-	-	3.15	-	3.15	-	V
Voltage				6	4.2	-	-	4.2	-	4.2	-	V
SIG _{IN} , COMP _{IN}	V _{IL}	-	-	2	-	-	0.5	-	0.5	-	0.5	V
DC Coupled Low-Level Input				4.5	-	-	1.35	-	1.35	-	1.35	V
Voltage				6	-	-	1.8	-	1.8	-	1.8	V
PCP _{OUT} , PCn OUT	V _{OH}	V _{IL} or V _{IH}	-0.02	2	1.9	-	-	1.9	-	1.9	-	V
High-Level Output Voltage				4.5	4.4	-	-	4.4	-	4.4	-	V
CMOS Loads				6	5.9	-	-	5.9	-	5.9	-	V
PCP _{OUT} , PCn OUT	V _{OH}	V _{IL} or V _{IH}	-4	4.5	3.98	-	-	3.84	-	3.7	-	V
High-Level Output Voltage TTL Loads			-5.2	6	5.48	-	-	5.34	-	5.2	-	V
PCP _{OUT} , PCn OUT	V _{OL}	V _{IL} or V _{IH}	0.02	2	-	-	0.1	-	0.1	-	0.1	V
Low-Level Output Voltage	_			4.5	-	-	0.1	-	0.1	-	0.1	V
CMOS Loads				6	-	-	0.1	-	0.1	-	0.1	V
PCP _{OUT} , PCn OUT	V _{OL}	VIL or VIH	4	4.5	-	-	0.26	-	0.33	-	0.4	V
Low-Level Output Voltage TTL Loads			5.2	6	-	-	0.26	-	0.33	-	0.4	V
SIG _{IN} , COMP _{IN} Input	Ц	V _{CC} or	-	2	-	-	±3	-	±4	-	±5	μΑ
Leakage Current		GND		3	-	-	±7	-	±9	-	±11	μΑ
				4.5	-	-	±18	-	±23	-	±29	μΑ
				6	-	-	±30	-	±38	-	±45	μΑ
PC2 _{OUT} Three-State Off-State Current	loz	V _{IL} or V _{IH}	-	6	-	-	±0.5	-	±5	-	±10	μA
SIG _{IN} , COMP _{IN} Input	R _I	V _I at Se		3	-	800	-	-	-	-	-	kΩ
Resistance		Operatio ΔV _I =		4.5	-	250	-	-	-	-	-	kΩ
		See Fig		6	-	150	-	-	-	-	-	kΩ
DEMODULATOR SEC			Į					•				
Resistor Range	R _S	at R _S >		3	50	-	300	-	-	-	-	kΩ
		Leakage Can Inf		4.5	50	-	300	-	-	-	-	kΩ
		V _{DEN}		6	50	-	300	-	-	-	-	kΩ

CD54HC4046A, CD74HC4046A, CD54HCT4046A, CD74HCT4046A

DC Electrical Specifications (Continued) TEST CONDITIONS 25°C -40°C TO 85°C -55°C TO 125°C Vcc PARAMETER SYMBOL MIN TYP MAX MIN MAX MIN MAX UNITS V_I (V) I_O (mA) (V) Offset Voltage VCOIN VOFF VI = VVCO IN = 3 -±30 ----m٧ V_{CC} to V_{DEM} 4.5 ±20 m٧ -_ ----2 6 _ ±10 -_ m٧ Values Taken Over --Rs Range See Figure 23 Dynamic Output R_D 3 25 Ω V_{DEMOUT} = -_ ----V_{CC} 2 Resistance at 4.5 -25 _ 0 _ _ -_ DEMOUT 6 25 Ω _ _ _ --_ **Quiescent Device** Icc Pins 3, 5 and 14 6 -_ 8 -80 -160 μΑ Current at V_{CC} Pin 9 at GND, I₁ at Pins 3 and 14 to be excluded HCT TYPES VCO SECTION INH High Level Input VIH _ 4.5 to 2 _ 2 _ 2 V Voltage 5.5 INH Low Level Input VIL 4.5 to 0.8 0.8 0.8 V ---_ _ -Voltage 5.5 VCO_{OUT} High Level VOH -0.02 4.5 4.4 4.4 4.4 V VIH or VIL ----Output Voltage CMOS Loads VCO_{OUT} High Level -4 4.5 3.98 --3.84 -3.7 -V **Output Voltage** TTL Loads VOL VCO_{OUT} Low Level VIH or VIL 0.02 4.5 0.1 0.1 0.1 V _ ---Output Voltage CMOS Loads V VCO_{OUT} Low Level 4 4.5 0.26 0.33 ----0.4 Output Voltage TTL Loads C1A, C1B Low Level V VOL 4 4.5 0.40 0.47 0.54 VIH or VIL -_ --**Output Voltage** (Test Purposes Only) INH VCOIN Input Ιį. Any Voltage 5.5 ±0.1 -- ± 1 -±1 μΑ Leakage Current Between V_{CC} and GND R1 Range (Note 2) -4.5 3 -300 ---kΩ -3 R2 Range (Note 2) 4.5 300 -------kΩ C1 Capacitance _ -_ 4.5 0 -No _ _ -pF Range Limit VCOIN Operating Over the range 4.5 V _ 1.1 _ 3.2 _ -Voltage Range specified for R1 for Linearity See Figure 10, and 34 - 37 (Note 3) PHASE COMPARATOR SECTION SIGIN, COMPIN VIH 4.5 to 2 2 2 ٧ -DC Coupled 5.5 High-Level Input Voltage

DC Electrical Specifications (Continued)

		TE: CONDI		Vcc		25 ⁰ C		-40°C 1	O 85°C	-55°C T	O 125 ⁰ C	
PARAMETER	SYMBOL	V _I (V)	I _O (mA)	(V)	MIN	TYP	MAX	MIN	MAX	MIN	MAX	UNITS
SIG _{IN} , COMP _{IN} DC Coupled Low-Level Input Voltage	V _{IL}	-	-	4.5 to 5.5	-	-	0.8	-	0.8	-	0.8	V
PCP _{OUT} , PCn OUT High-Level Output Voltage CMOS Loads	V _{OH}	V _{IL} or V _{IH}	-	4.5	4.4	-	-	4.4	-	4.4	-	V
PCP _{OUT} , PCn OUT High-Level Output Voltage TTL Loads	V _{OH}	V _{IL} or V _{IH}	-	4.5	3.98	-	-	3.84	-	3.7	-	V
PCP _{OUT} , PCn OUT Low-Level Output Voltage CMOS Loads	V _{OL}	V _{IL} or V _{IH}	-	4.5	-	-	0.1	-	0.1	-	0.1	V
PCP _{OUT} , PCn OUT Low-Level Output Voltage TTL Loads	V _{OL}	V _{IL} or V _{IH}	-	4.5	-	-	0.26	-	0.33	-	0.4	V
SIG _{IN} , COMP _{IN} Input Leakage Current	Ι	Any Voltage Between V _{CC} and GND	-	5.5	-	-	±30		±38		±45	μA
PC2 _{OUT} Three-State Off-State Current	l _{oz}	V _{IL} or V _{IH}	-	5.5	-	-	±0.5	±5	-	-	±10	μA
SIG _{IN} , COMP _{IN} Input Resistance	RI	V _I at Se Operatio ∆V _I = See Fig	n Point: 0.5V,	4.5	-	250	-	-	-	-	-	kΩ
DEMODULATOR SEC	TION	-			-		-	-		-		
Resistor Range	R _S	at R _S > Leakage Can Inf V _{DEM}	Current luence OUT	4.5	5	-	300	-	-	-	-	kΩ
Offset Voltage VCO _{IN} to V _{DEM}	V _{OFF}	$V_{I} = V_{VC}$ $\frac{V_{CC}}{2}$ Values ta R _S Ra See Fig	ken over ange	4.5	-	±20	-	-	-	-	-	mV
Dynamic Output Resistance at DEM _{OUT}	R _D	$\frac{V_{\text{DEM}}}{\frac{V_{\text{CC}}}{2}}$	= TUC	4.5	-	25	-	-	-	-	-	Ω
Quiescent Device Current	Icc	V _{CC} or GND	-	5.5	-	-	8	-	80	-	160	μA
Additional Quiescent Device Current Per Input Pin: 1 Unit Load	∆I _{CC} (Note 4)	V _{CC} -2.1 Excluding Pin 5	-	4.5 to 5.5	-	100	360	-	450	-	490	μA

NOTES:

2. The value for R1 and R2 in parallel should exceed $2.7 k \Omega.$

3. The maximum operating voltage can be as high as V_{CC} -0.9V, however, this may result in an increased offset voltage.

4. For dual-supply systems theoretical worst case (V_I = 2.4V, V_{CC} = 5.5V) specification is 1.8mA.

HCT Input Loading Table

INPUT	UNIT LOADS
INH	1

NOTE: Unit load is ΔI_{CC} limit specific in DC Electrical Specifications Table, e.g., 360µA max. at 25°C.

Switching Specifications $C_L = 50 pF$, Input t_r , $t_f = 6 ns$

		TEST			25 ⁰ C		-40 ⁰ 85			С ТО 5°С	
PARAMETER	SYMBOL	CONDITIONS	V _{CC} (V)	MIN	TYP	MAX	MIN	MAX	MIN	MAX	
HC TYPES											
PHASE COMPARATOR SECTI	ON										
Propagation Delay	t _{PLH} , t _{PHL}										
SIG_{IN} , COMP _{IN} to PCI _{OUT}			2	-	-	200	-	250	-	300	ns
			4.5	-	-	40	-	50	-	60	ns
			6	-	-	34	-	43	-	51	ns
SIG_{IN} , COMP _{IN} to PCP _{OUT}			2	-	-	300	-	375	-	450	ns
			4.5	-	-	60	-	75	-	90	ns
			6	-	-	51	-	64	-	77	ns
SIG _{IN} , COMP _{IN} to PC3 _{OUT}			2	-	-	245	-	305	-	307	ns
			4.5	-	-	49	-	61	-	74	ns
			6	-	-	42	-	52	-	63	ns
Output Transition Time	t _{THL} , t _{TLH}		2	-	-	75	-	95	-	110	ns
			4.5	-	-	15	-	19	-	22	ns
			6	-	-	13	-	16	-	19	ns
Output Enable Time, SIG _{IN} , COMP _{IN} to PC2 _{OUT}	t _{PZH} , t _{PZL}		2	-	-	265	-	330	-	400	ns
			4.5	-	-	53	-	66	-	80	ns
			6	-	-	45	-	56	-	68	ns
Output Disable Time, SIG _{IN} ,	t _{PHZ} , t _{PLZ}		2	-	-	315	-	395	-	475	ns
COMP _{IN} to PC2 _{OUT}			4.5	-	-	63	-	79	-	95	ns
			6	-	-	54	-	67	-	77 307 74 63 110 22 19 400 80 68 475	ns
AC Coupled Input Sensitivity		V _{I(P-P)}	3	-	11	-	-	-	- 110 - 22 - 19 - 400 - 80 - 68 - 95 - 95 - 81 - - - - - - - - - - - - - - - - - - - - - - - - - - - - - - - -	mV	
(_{P-P}) at SIG _{IN} or COMP _{IN}			4.5	-	15	-	-	-	-	-	mV
			6	-	33	-	-	-	-	-	mV
VCO SECTION											
Frequency Stability with	Δf	R ₁ = 100kΩ,	3	-	0.11	-	-	-	-	-	%/ºC
Temperature Change	$\overline{\Delta}\overline{T}$	$R_2 = \infty$	4.5	-	0.11	-	-	-	-	-	%/ºC
			6	-	0.11	-	-	-	-	-	%/ºC
Maximum Frequency	f _{MAX}	C ₁ = 50pF	3	-	24	-	-	-	-	-	MHz
		$R_1 = 3.5k\Omega$ $R_2 = \infty$	4.5	-	24	-	-	-	-	-	MHz
		112 = 00	6	-	24	-	-	-	-	-	MHz
		C ₁ = 0pF	3	-	38	-	-	-	-	- 1	MHz
		$R_1 = 9.1 k\Omega$ $R_2 = \infty$	4.5	-	38	-	-	-	-	-	MHz
		r ₂ = ∞	6	-	38	-	-	-	-	-	MHz

		TEST			25 ⁰ C		-40°(85	с то ⁰С	-55 ⁰ 125	С ТО 5°С	
PARAMETER	SYMBOL	CONDITIONS	V _{CC} (V)	MIN	TYP	MAX	MIN	MAX	MIN	MAX	UNITS
Center Frequency		C ₁ = 40pF	3	7	10	-	-	-	-	-	MHz
		$R_1 = 3k\Omega$ $R_2 = \infty$	4.5	12	17	-	-	-	-	-	MHz
		VCO _{IN} = VCC/2	6	14	21	-	-	-	-	-	MHz
Frequency Linearity	Δf _{VCO}	$R_1 = 100k\Omega$	3	-	0.4	-	-	-	-	-	%
		$R_2 = \infty$ $C_1 = 100 pF$	4.5	-	0.4	-	-	-	-	-	%
			6	-	0.4	-	-	-	-	-	%
Offset Frequency		$R_2 = 220k\Omega$	3	-	400	-	-	-	-	-	kHz
		C ₁ = 1nF	4.5	-	400	-	-	-	-	-	kHz
			6	-	400	-	-	-	-	-	kHz
DEMODULATOR SECTION											
V _{OUT} V _S f _{IN}		R ₁ = 100kΩ	3	-	-	-	-	-	-	-	mV/kHz
		$R_2 = \infty$ $C_1 = 100 pF$	4.5	-	330	-	-	-	-	-	mV/kHz
		$R_{S} = 10kΩ$ $R_{3} = 100kΩ$ $C_{2} = 100pF$	6	-	-	-	-	-	-	-	mV/kHz
HCT TYPES		- 2 1									
PHASE COMPARATOR SECTI	ON										
Propagation Delay	t _{PHL} , t _{PLH}										
SIG _{IN} , COMP _{IN} to PCI _{OUT}	· · · ·	$C_L = 50 pF$	4.5	-	-	45	-	56	-	68	ns
SIG _{IN} , COMP _{IN} to PCP_{OUT}	t _{PHL} , t _{PLH}	C _L = 50pF	4.5	-	-	68	-	85	-	102	ns
SIG _{IN} , COMP _{IN} to PC3 _{OUT}	t _{PHL} , t _{PLH}	C _L = 50pF	4.5	-	-	58	-	73	-	87	ns
Output Transition Time	t _{TLH} , t _{THL}	C _L = 50pF	4.5	-	-	15	-	19	-	22	ns
Output Enable Time, SIG _{IN} , COMP _{IN} to PC2 _{OUT}	^t PZH ^{, t} PZL	C _L = 50pF	4.5	-	-	60	-	75	-	90	pF
Output Disable Time, SIG _{IN} , COMP _{IN} to PCZ _{OUT}	t _{PHZ} , t _{PLZ}	C _L = 50pF	4.5	-	-	68	-	85	-	102	pF
AC Coupled Input Sensitivity (P_{P}) at SIG _{IN} or COMP _I		V _{I(P-P)}	4.5	-	15	-	-	-	-	-	mV
VCO SECTION											
Frequency Stability with Temperature Change	$\frac{\Delta f}{\overline{\Delta T}}$	$R_1 = 100k\Omega, \\ R_2 = \infty$	4.5	-	0.11	-	-	-	-	-	%/ºC
Maximum Frequency	f _{MAX}	$C_1 = 50 \text{pF}$ $R_1 = 3.5 \text{k}\Omega$ $R_2 = \infty$	4.5	-	24	-	-	-	-	-	MHz
		$C_1 = 0$ pF R ₁ = 9.1kΩ R ₂ = ∞	4.5	-	38	-	-	-	-	-	MHz
Center Frequency		$C_{1} = 40 \text{pF}$ $R_{1} = 3 \text{k} \Omega$ $R_{2} = \infty$ $VCO_{\text{IN}} =$ $VCC/2$	4.5	12	17	-	-	-	-	-	MHz
Frequency Linearity	Δf _{VCO}	$R_1 = 100k\Omega$ $R_2 = \infty$ $C_1 = 100pF$	4.5	-	0.4	-	-	-	-	-	%

		TEST CONDITIONS	V _{CC} (V)	25 ⁰ C			-40°C TO 85 [°] C		-55°C TO 125°C			
PARAMETER	SYMBOL			MIN	TYP	MAX	MIN	MAX	MIN	MAX	UNITS	
Offset Frequency		$\begin{array}{c} R_2 = 220 k\Omega \\ C_1 = 1nF \end{array}$	4.5	-	400	-	-	-	-	-	kHz	
DEMODULATOR SECTION												
V _{OUT} V _S f _{IN}			4.5	-	330	-	-	-	-	-	mV/kHz	

Test Circuits and Waveforms

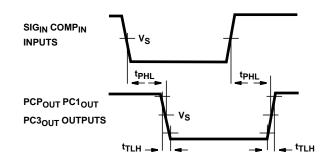


FIGURE 8. INPUT TO OUTPUT PROPAGATION DELAYS AND OUTPUT TRANSITION TIMES

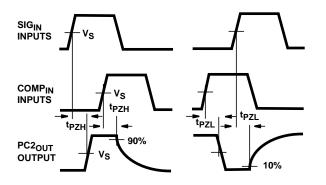
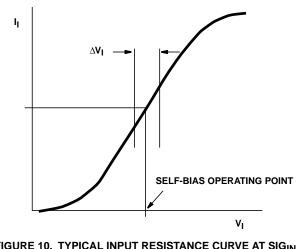
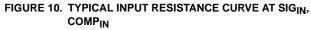


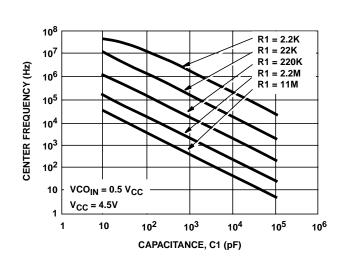
FIGURE 9. THREE STATE ENABLE AND DISABLE TIMES FOR PC2_{OUT}

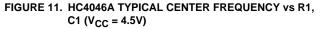
Typical Performance Curves





Typical Performance Curves (Continued)





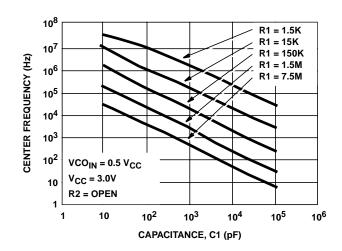
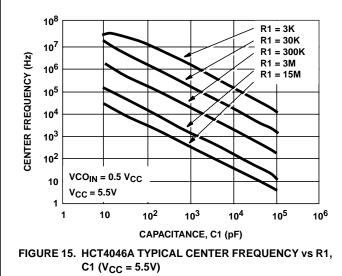


FIGURE 13. HC4046A TYPICAL CENTER FREQUENCY vs R1, C1 (V_{CC} = 3V, R2 = OPEN)



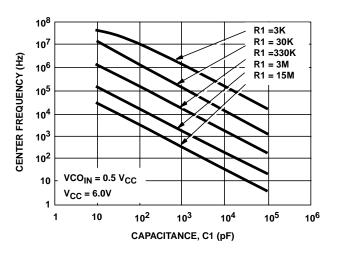


FIGURE 12. HC4046A TYPICAL CENTER FREQUENCY vs R1, C1 (V_{CC} = 6V)

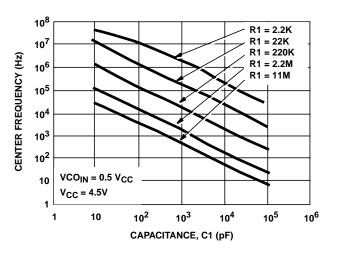
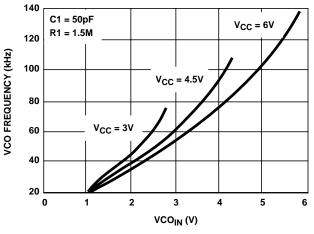
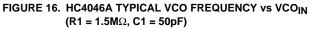
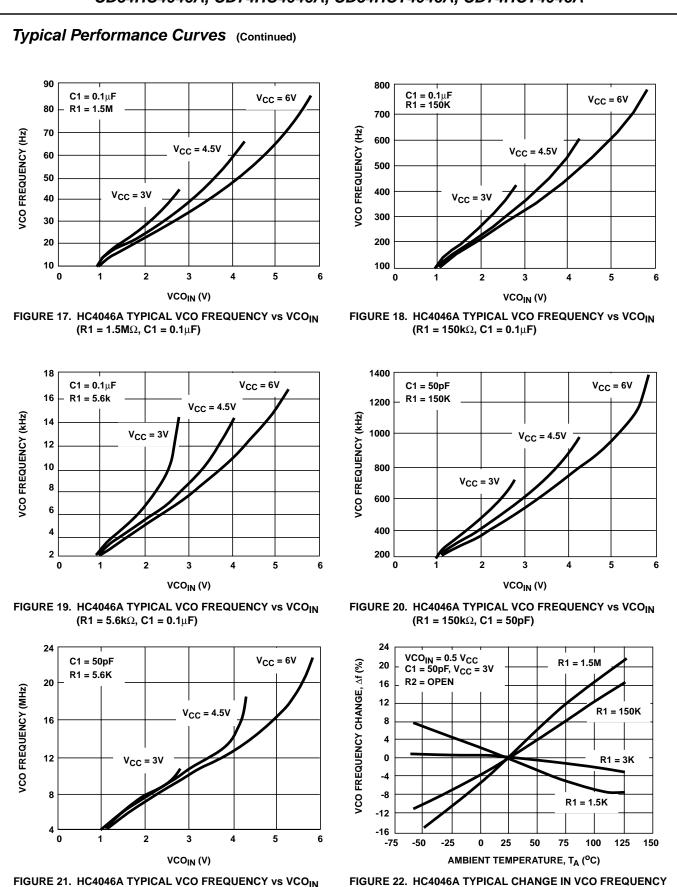


FIGURE 14. HCT4046A TYPICAL CENTER FREQUENCY vs R1, C1 (V_{CC} = 4.5V)









vs AMBIENT TEMPERATURE AS A FUNCTION OF

Typical Performance Curves (Continued)

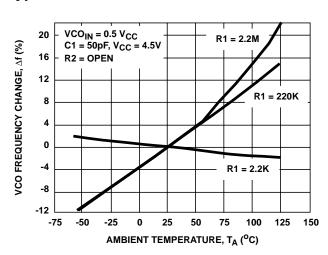
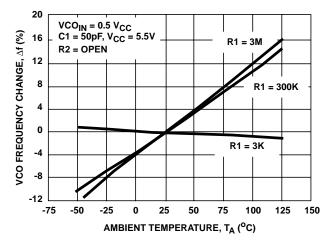


FIGURE 23. HC4046A TYPICAL CHANGE IN VCO FREQUENCY vs AMBIENT TEMPERATURE AS A FUNCTION OF R1 (V_{CC} = 4.5V)





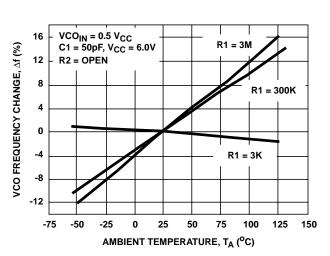


FIGURE 24. HC4046A TYPICAL CHANGE IN VCO FREQUENCY vs AMBIENT TEMPERATURE AS A FUNCTION OF R1 (V_{CC} = 6V)

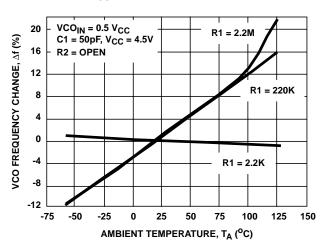
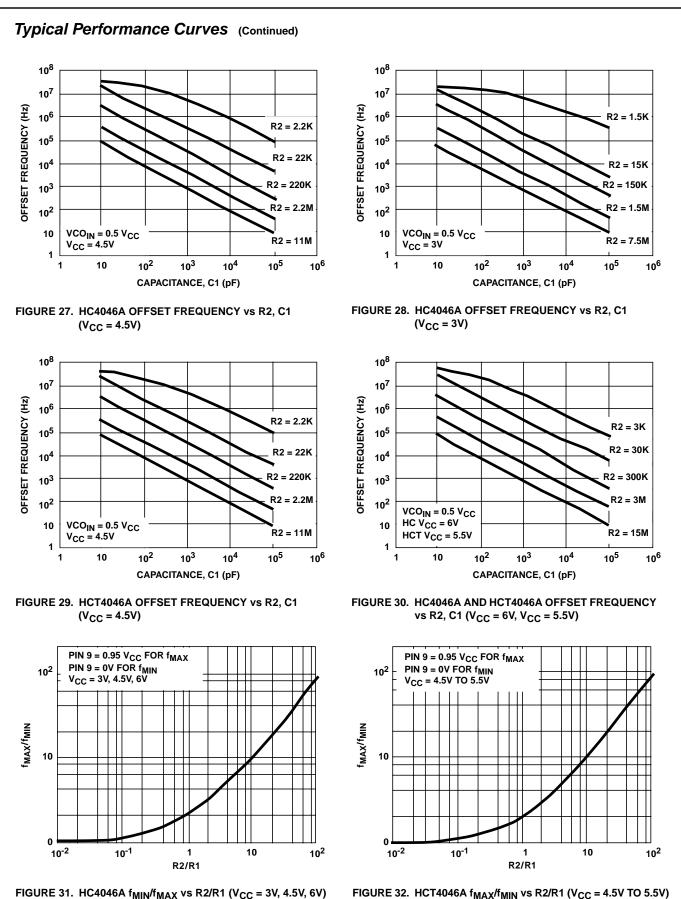
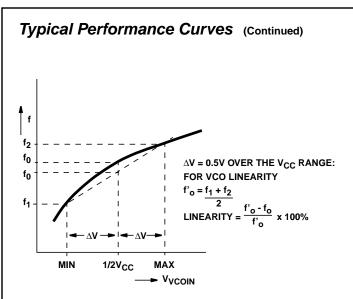


FIGURE 26. HC4046A TYPICAL CHANGE IN VCO FREQUENCY vs AMBIENT TEMPERATURE AS A FUNCTION OF R1 (V_{CC} = 4.5V)







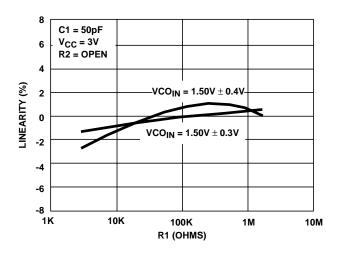
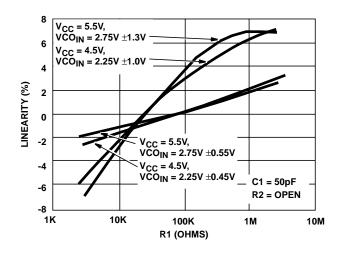
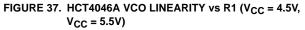


FIGURE 35. HC4046A VCO LINEARITY vs R1 (V_{CC} = 3V)





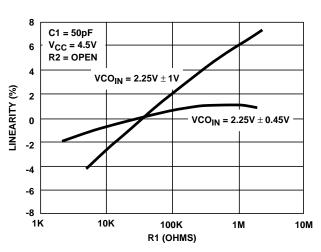
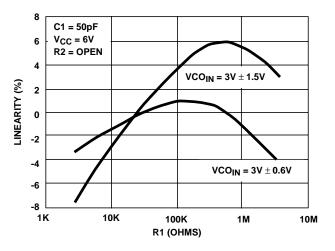
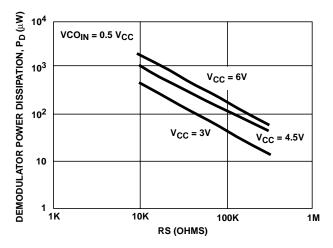
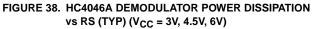


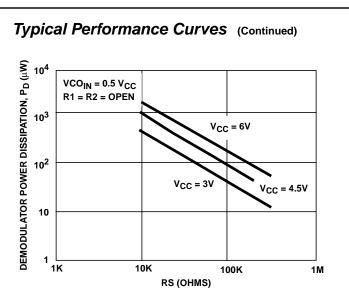
FIGURE 34. HC4046A VCO LINEARITY vs R1 (V_{CC} = 4.5V)

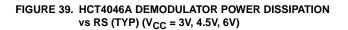












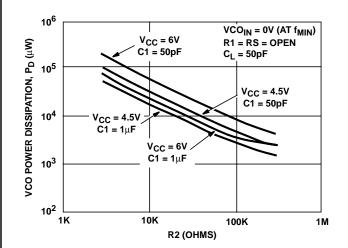
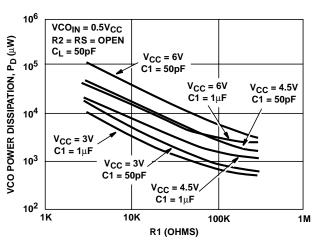


FIGURE 41. HCT4046A VCO POWER DISSIPATION vs R2 $(C1 = 50pF, 1\mu F)$





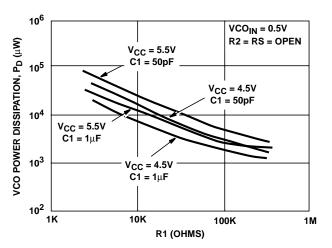


FIGURE 42. HCT4046A VCO POWER DISSIPATION vs R1 (C1 = 50pF, 1μ F)

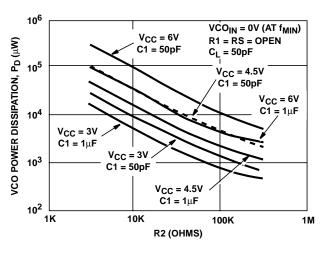


FIGURE 43. HC4046A VCO POWER DISSIPATION vs R2 (C1 = 50pF, 1µF)

HC/HCT4046A C _{PD}					
CHIP SECTION	НС	НСТ	UNIT		
Comparator 1	48	50	pF		
Comparators 2 and 3	39	48	pF		
VCO	61	53	pF		

Application Information

This information is a guide for the approximation of values of external components to be used with the 'HC4046A and 'HCT4046A in a phase-lock-loop system.

References should be made to Figures 11 through 15 and Figures 27 through 32 as indicated in the table.

Values of the selected components should be within the following ranges:

R1	Between $3\text{k}\Omega$ and $300\text{k}\Omega$
R2	Between $3\text{k}\Omega$ and $300\text{k}\Omega$
R1 + R2	Parallel Value > 2.7k Ω
C1	Greater Than 40pF

SUBJECT	PHASE COMPARATOR	DESIGN CONSIDERATIONS	
VCO Frequency Without Extra Offset	PC1, PC2 or PC3	VCO Frequency Characteristic With R2 = ∞ and R1 within the range $3k\Omega < R1 < 300k\Omega$, the characteristics of the VCO operation will be as shown in Figures 11 - 15. (Due to R1, C1 time constant a small offset remains when R2 = ∞ .)	
		f _{MAX} f _{VCO} f _o	
		f _{MIN} MIN 1/2 V _{CC} V _{VCOIN} MAX	
		FIGURE 44. FREQUENCY CHARACTERISTIC OF VCO OPERATING WITHOUT OFFSET: f_0 = CENTER FREQUENCY: $2f_L$ = FREQUENCY LOCK RANGE	
	PC1	Selection of R1 and C1 Given f _o , determine the values of R1 and C1 using Figures 11 - 15	
	PC2 or PC3	Given f_{MAX} calculate f_0 as $f_{MAX}/2$ and determine the values of R1 and C1 using Figures 11 - 15. To obtain $2f_L: 2f_L \approx 1.2 (V_{CC} - 1.8V)/(R1C1)$ where valid range of VCO _{IN} is $1.1V < VCO_{IN} < V_{CC} - 0.9V$	
VCO Frequency with Extra Offset	PC1, PC2 or PC3		
		f _{MAX} fvco f _o	
		f _{MIN}	
		MIN 1/2 V _{CC} V _{VCOIN} MAX	
		FIGURE 45. FREQUENCY CHARACTERISTIC OF VCO OPERATING WITH OFFSET: $f_0 = CENTER FREQUENCY: 2f_L = FREQUENCY LOCK RANGE$	
	PC1, PC2 or PC3	Selection of R1, R2 and C1 Given f_0 and f_L , offset frequency, f_{MIN} , may be calculated from $f_{MIN} \approx f_0 - 1.6 f_L$. Obtain the values of C1 and R2 by using Figures 27 - 30. Calculate the values of R1 from Figures 31 - 32.	

CD54HC4046A, CD74HC4046A, CD54HCT4046A, CD74HCT4046A

SUBJECT	PHASE COMPARATOR	DESIGN CONSIDERATIONS
PLL Conditions with No Signal at the SIG _{IN} Input	PC1	VCO adjusts to f_0 with $\phi_{DEMOUT} = 90^{\circ}$ and $V_{VCOIN} = 1/2 V_{CC}$ (see Figure 2)
	PC2	VCO adjusts to f_{MIN} with ϕ_{DEMOUT} = -360 ^o and V_{VCOIN} = 0V (see Figure 4)
	PC3	VCO adjusts to f_{MAX} with $\phi_{DEMOUT} = 360^{\circ}$ and $V_{VCOIN} = V_{CC}$ (see Figure 6)
PLL Frequency Capture Range	PC1, PC2 or PC3	Loop Filter Component Selection R3 INPUT C2 OUTPUT (A) $\tau = R3 \times C2$ (B) AMPLITUDE CHARACTERISTIC (C) POLE-ZERO DIAGRAM A small capture range (2f _c) is obtained if $\tau > 2f_c \approx 1/\pi (2\pi f_L/\tau.)^{1/2}$ FIGURE 46. SIMPLE LOOP FILTER FOR PLL WITHOUT OFFSET $\frac{R3}{INPUT} = \frac{R4}{R3 \times C2}$ (B) AMPLITUDE CHARACTERISTIC (C) POLE-ZERO DIAGRAM (A) $\tau 1 = R3 \times C2$; $\tau 2 = R4 \times C2$; $\tau 3 = (R3 + R4) \times C2$ FIGURE 47. SIMPLE LOOP FILTER FOR PLL WITH OFFSET
PLL Locks on	PC1 or PC3	Yes
Harmonics at Center Frequency	PC2	No
Noise Rejection at Signal Input	PC1	High
	PC2 or PC3	Low
AC Ripple Content	PC1	$f_r = 2f_i$, large ripple content at $\phi_{DEMOUT} = 90^{\circ}$
when PLL is Locked	PC2	$f_r = f_i$, small ripple content at $\phi_{DEMOUT} = 0^0$
	PC3	$f_r = fSIG_{IN}$, large ripple content at $\phi_{DEMOUT} = 180^{\circ}$